

● General Description

The AGM01P15E combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% DVDS tested

● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDS(ON)	ID
-100V	270mΩ	-4.3A

SOT-23-3 Pin Configuration

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
01P15	AGM01P15E	SOT-23-3	178mm	8mm	3000

Table 1. Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) (Note 1)	-4.3	A
	Drain Current-Continuous(Tc=100°C)	-2.9	A
IDM (pluse)	Drain Current-Pulsed (Note 2)	-17.2	A
PD	Maximum Power Dissipation(Tc=25°C)	1.25	w
	Maximum Power Dissipation(Tc=100°C)	1.0	w
EAS	Avalanche energy (Note 3)	30	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹	---	100	°C/W

Table 3. Electrical Characteristics (T_J=25°C unless otherwise noted)

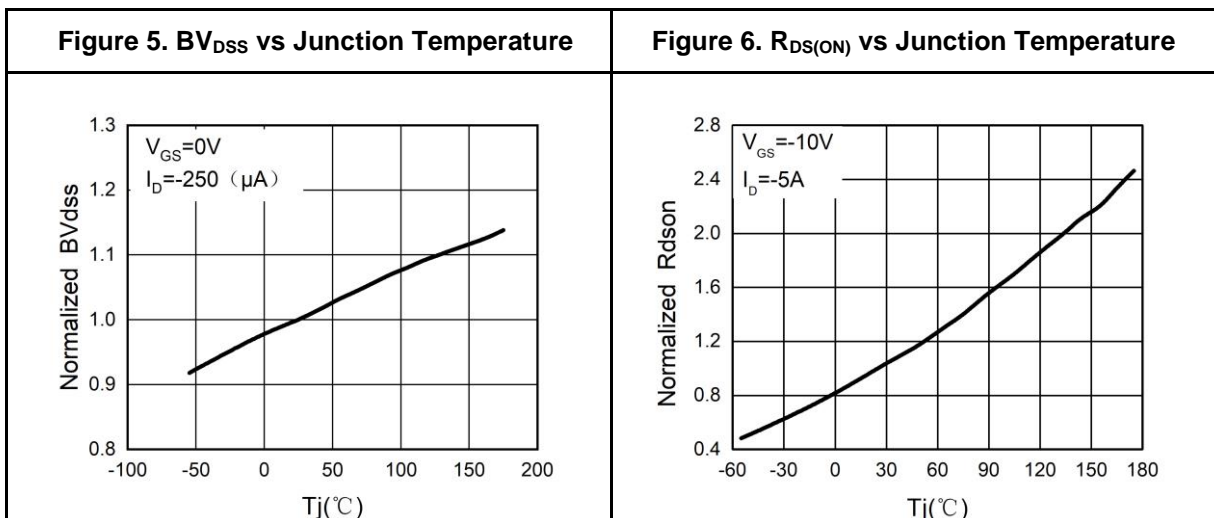
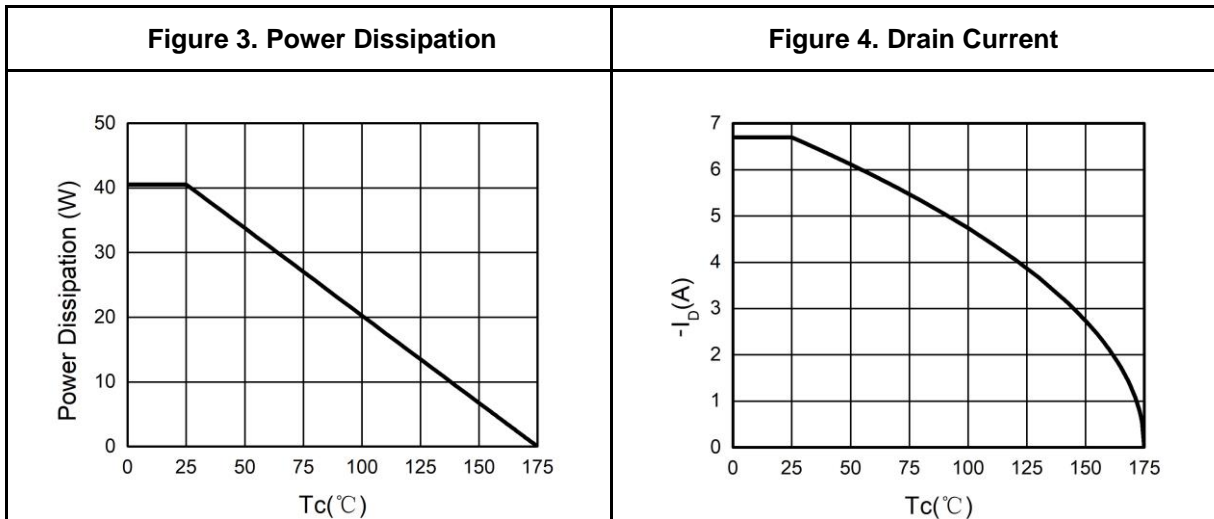
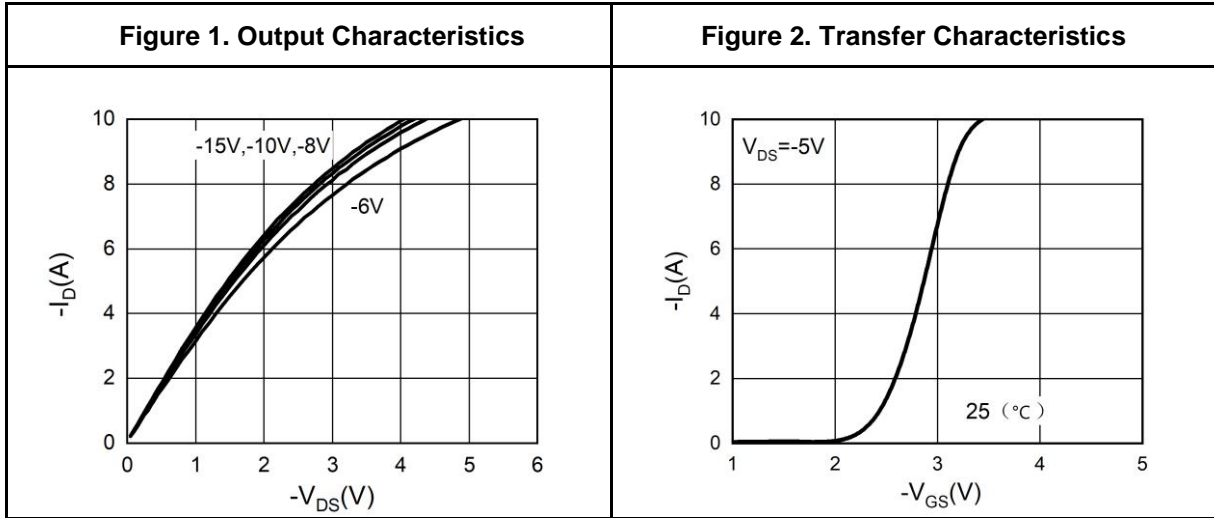
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V,VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1.2	-1.6	-2.2	V
gFS	Forward Transconductance	VDS=-5V,ID=-2A	--	7.0	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-4A	--	270	340	mΩ
		VGS=-4.5V, ID=-2A	--	280	330	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=-50V,VGS=0V, F=1MHZ	--	1199	--	pF
Coss	Output Capacitance		--	34	--	pF
Crss	Reverse Transfer Capacitance		--	28	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	5.2	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=-10V,VDS=-50V, RL=3Ω,RGEN=3Ω	--	13.5	--	nS
tr	Turn-on Rise Time		--	4.0	--	nS
td(off)	Turn-Off Delay Time		--	42	--	nS
tf	Turn-Off Fall Time		--	6.5	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-50V, ID=-3A	--	19.5	--	nC
Qgs	Gate-Source Charge		--	6.0	--	nC
Qgd	Gate-Drain Charge		--	4.1	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	-4.3	A
VSD	Forward on Voltage	VGS=0V,IS=-3A	--	--	-1.2	V
trr	Reverse Recovery Time	Isd=-3A , di/dt=100A/μs , TJ=25°C	--	43	--	ns
Qrr	Reverse Recovery Charge		--	84	--	nc

Notes 1.The maximum current rating is package limited.

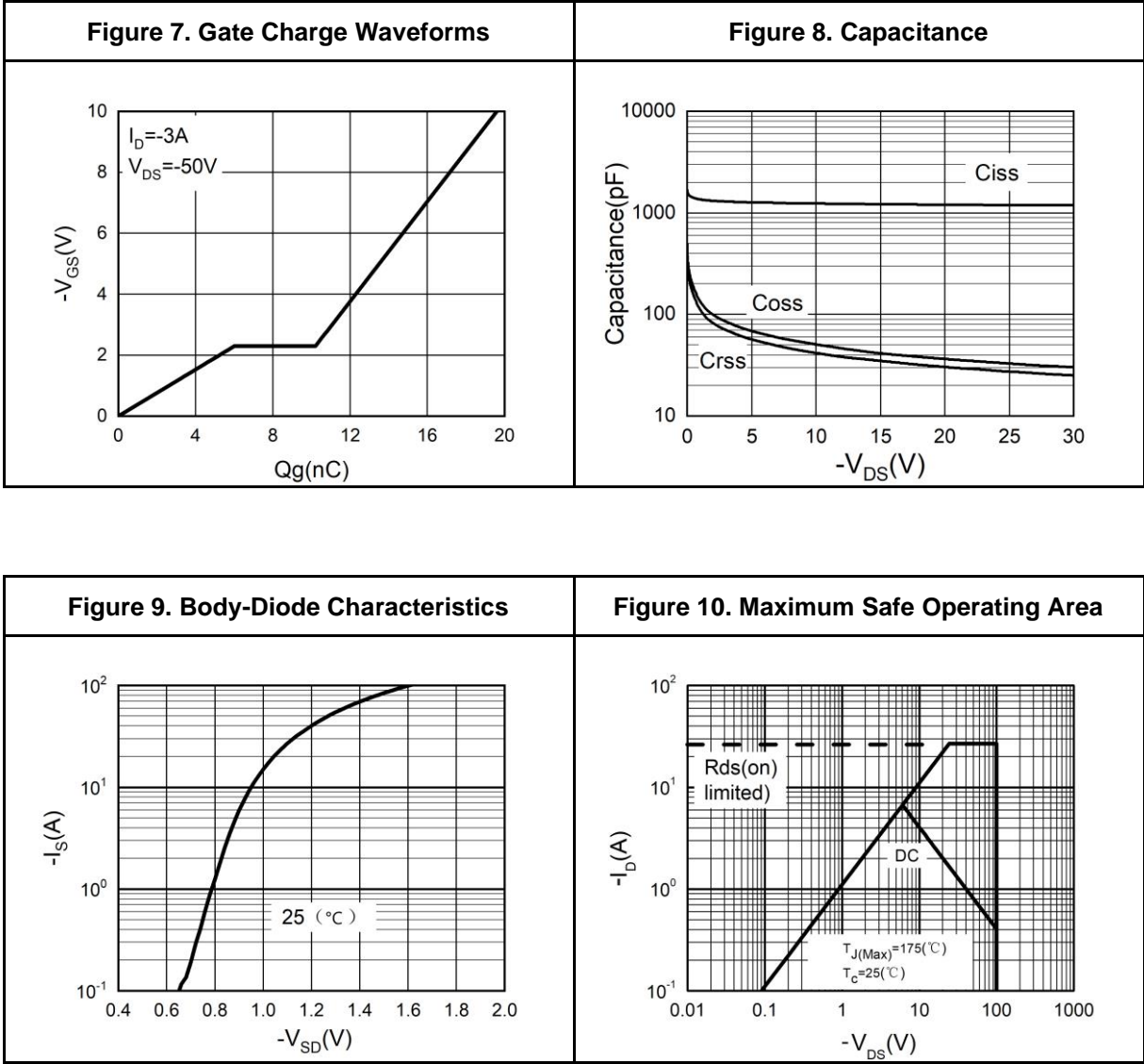
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

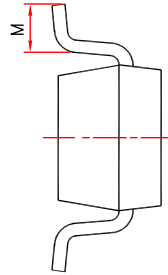
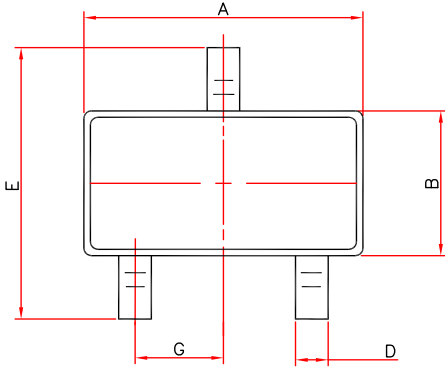
Notes 3.EAS condition: T_J=25°C

Typical Electrical And Thermal Characteristics (Curves)

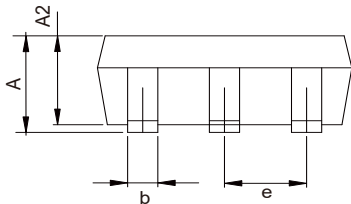
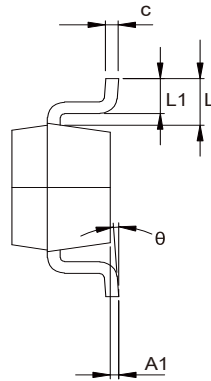
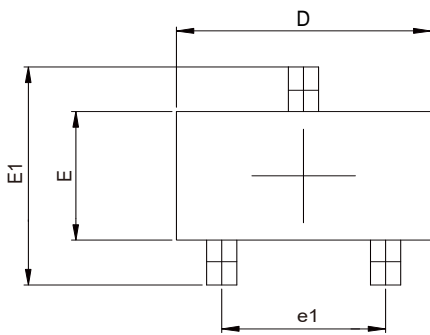
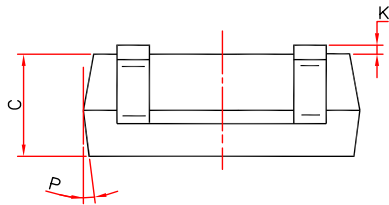


Typical Electrical And Thermal Characteristics (Curves)



Package Outline Data SOT-23-3


DIM	MILLIMETERS
A	2.82~3.02
B	1.60 ± 0.10
C	1.10 ± 0.05
D	0.40 ± 0.10
E	2.65~2.95
G	0.95typ
K	0.00~0.10
M	0.20MIN
P	9 ± 2°



COMMON DIMENSIONS CUNITS MEASURE=MILLIMETER			
SYMBOL			
A	1.050	---	1.300
A1	0.000	---	0.200
b	0.300	0.400	0.500
c	0.100	---	0.200
D	2.820	2.900	3.020
E	1.500	1.600	1.700
E1	2.650	2.800	2.950
e	0.950TYP		
e1	1.800	1.900	2.000
L	0.6REF		
L1	0.300	0.450	0.600
θ	0°	--	8°

Unit:mm


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